L Number	Hits	Search Text	DB	Time stamp
32	29	substrate with (polymer adj studs)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/09/29 17:45
33	36	polymer adj stud adj grid adj array	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/09/29 18:12
34	57	polymer adj studs	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/09/29 18:05
35	91	substrate adj studs	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/09/29 18:09
36	750	stud adj bump	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/09/29 18:11
37	13	(stud adj bump) with polymer	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/09/29 18:11
38	43	(polymer adj stud adj grid adj array) or psga	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/09/29 18:18
39	199	257/733.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/09/29 19:12
40	167	polymer adj connections	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/09/29 18:39
41	513	stud adj connections	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/09/29 18:46
43	52	((cylindrical adj projections) with diameter) and studs	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/09/29 18:48
44	11	((cylindrical adj projections) with diameter) same studs	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/09/29 18:48
45	6	((cylindrical adj projections) with diameter) with studs	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/09/29 18:49
46	0	((cylindrical adj projections) with diameter) near studs	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/09/29 18:49

47	1066	(cylindrical adj projections) with diameter	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/09/29 18:50
48	4	((cylindrical adj projections) with diameter) and 257/$.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/09/29 18:52
49	2	((cylindrical adj projections) with diameter) and 438/$.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/09/29 18:52
50	1055	257/734.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/09/29 19:14
51	1415	257/737.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/09/29 19:15
52	92	257/734.ccls. and polymer	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/09/29 19:15
53	260	257/737.ccls. and polymer	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/09/29 19:15